

Product/process change notification

PCN N° 2021-215-A

Dear customer,

Please find attached our Infineon Technologies AG PCN:

Several changes affecting product 2EDF7275K for package TFLGA-13

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before 2022-09-30
- Infineon aligns with the widely recognized JEDEC STANDARD "JESD46", which stipulates: "Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change."

Your prompt reply will help Infineon to assure a smooth and well-executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.



On 16 April 2020, Infineon acquired Cypress.

We are now in the process of merging and consolidating our tools and processes for PCN, Information Notes, Errata and Product Discontinuance.

For further details, please visit our website:

https://www.infineon.com/cms/en/about-infineon/company/cypress-acquisition/

Infineon Technologies AG

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Products affected

Please refer to attached affected product list "PCN 2021-215-A_[customer-no].pdf"

Detailed change information

Subject

Several changes affecting product 2EDF7275K for package TFLGA-13.

Reason

The assembly production of the affected product will be transferred to Cypress Semiconductor (Thailand) Limited, Nonthaburi, Thailand according to the global Infineon production strategy.

Description	Old	New
Assembly site	 ATX Assembly & Test (Shanghai) Ltd., Shanghai, China 	 Cypress Semiconductor (Thailand) Limited, Nonthaburi, Thailand
Package name	■ PG-TFLGA-13-1	■ PG-TFLGA-13-4
Molding compound	■ Kyocera KEG1250 LKDS	■ Shinetsu KMC3580LVA
Bonding wire	■ 25µm Au	■ 25µm CuPdAu
Datasheet	■ Rev 2.7	■ Rev 2.8

Product identification

Traceability is ensured via bau number, lot number, date code and marking. No change in SP ordering number. Please refer to 3_cip21215_a.

Impact of change

Based on the qualification performed, Infineon does not see any negative impact on quality, function and reliability. For detailed information please refer to 3_cip21215_a.

Attachments

PCN_2021-215-A_[customer-no].pdf 2_cip21215_a 3_cip21215_a affected product list qualification test report information package



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▶ Time schedule

Final qualification report available (see 2_cip21215_a)

First samples available on request

Intended start of delivery 2022-11-30

If you have any questions, please do not hesitate to contact your local sales office.